

# NGD8205N, NGD8205AN

## Ignition IGBT

### 20 Amp, 350 Volt, N-Channel DPAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Overvoltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

#### Features

- Ideal for Coil-on-Plug and Driver-on-Coil Applications
- DPAK Package Offers Smaller Footprint for Increased Board Space
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage for Interfacing Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Optional Gate Resistor ( $R_G$ ) and Gate-Emitter Resistor ( $R_{GE}$ )
- These are Pb-Free Devices

#### Applications

- Ignition Systems

#### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	390	V
Collector-Gate Voltage	$V_{CER}$	390	V
Gate-Emitter Voltage	$V_{GE}$	$\pm 15$	V
Collector Current-Continuous @ $T_C = 25^\circ\text{C}$ - Pulsed	$I_C$	20 50	$A_{DC}$ $A_{AC}$
Continuous Gate Current	$I_G$	1.0	mA
Transient Gate Current ( $t \leq 2$ ms, $f \leq 100$ Hz)	$I_G$	20	mA
ESD (Charged-Device Model)	ESD	2.0	kV
ESD (Human Body Model) $R = 1500 \Omega$ , $C = 100$ pF	ESD	8.0	kV
ESD (Machine Model) $R = 0 \Omega$ , $C = 200$ pF	ESD	400	V
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	125 0.83	W W/ $^\circ\text{C}$
Operating & Storage Temperature Range	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$

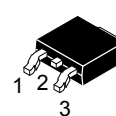
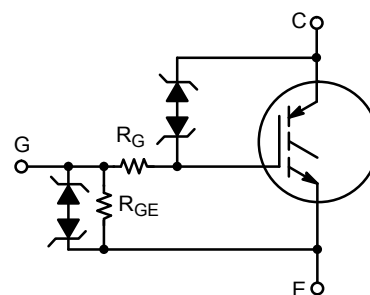
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



Expertise Applied | Answers Delivered

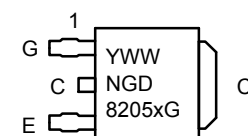
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**20 A, 350 V**  
 $V_{CE(on)} = 1.3 \text{ V @}$   
 $I_C = 10 \text{ A, } V_{GE} \geq 4.5 \text{ V}$



**DPAK**  
**CASE 369C**  
**STYLE 7**

#### MARKING DIAGRAM



Y = Year  
 WW = Work Week  
 NGD8205x = Device Code  
 x = N or A  
 G = Pb-Free Package

#### ORDERING INFORMATION

Device	Package	Shipping†
NGD8205NT4G	DPAK (Pb-Free)	2500 / Tape & Reel
NGD8205ANT4G	DPAK (Pb-Free)	2500 / Tape & Reel

# NGD8205N, NGD8205AN

## UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS ( $-55^{\circ} \leq T_J \leq 175^{\circ}C$ )

Characteristic	Symbol	Value	Unit
Single Pulse Collector-to-Emitter Avalanche Energy $V_{CC} = 50\text{ V}$ , $V_{GE} = 5.0\text{ V}$ , Pk $I_L = 16.7\text{ A}$ , $R_G = 1000\ \Omega$ , $L = 1.8\text{ mH}$ , Starting $T_J = 25^{\circ}C$ $V_{CC} = 50\text{ V}$ , $V_{GE} = 5.0\text{ V}$ , Pk $I_L = 14.9\text{ A}$ , $R_G = 1000\ \Omega$ , $L = 1.8\text{ mH}$ , Starting $T_J = 150^{\circ}C$ $V_{CC} = 50\text{ V}$ , $V_{GE} = 5.0\text{ V}$ , Pk $I_L = 14.1\text{ A}$ , $R_G = 1000\ \Omega$ , $L = 1.8\text{ mH}$ , Starting $T_J = 175^{\circ}C$	$E_{AS}$	250 200 180	mJ
Reverse Avalanche Energy $V_{CC} = 100\text{ V}$ , $V_{GE} = 20\text{ V}$ , Pk $I_L = 25.8\text{ A}$ , $L = 6.0\text{ mH}$ , Starting $T_J = 25^{\circ}C$	$E_{AS(R)}$	2000	mJ

## THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.2	$^{\circ}C/W$
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	95	$^{\circ}C/W$
Maximum Temperature for Soldering Purposes, 1/8" from case for 5 seconds (Note 2)	$T_L$	275	$^{\circ}C$

1. When surface mounted to an FR4 board using the minimum recommended pad size.

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Collector-Emitter Clamp Voltage	$BV_{CES}$	$I_C = 2.0\text{ mA}$	$T_J = -40^{\circ}C$ to $175^{\circ}C$	325	350	375	V
		$I_C = 10\text{ mA}$	$T_J = -40^{\circ}C$ to $175^{\circ}C$	340	365	390	
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{GE} = 0\text{ V}$ , $V_{CE} = 15\text{ V}$	$T_J = 25^{\circ}C$		0.1	1.0	$\mu A$
			$T_J = 175^{\circ}C$	0.5	1.5	10	
		$V_{CE} = 175\text{ V}$ , $V_{GE} = 0\text{ V}$	$T_J = 175^{\circ}C$	1.0	25	100*	$\mu A$
			$T_J = -40^{\circ}C$	0.4	0.8	5.0	
Reverse Collector-Emitter Clamp Voltage	$BV_{CES(R)}$	$I_C = -75\text{ mA}$	$T_J = 25^{\circ}C$	30	35	39	V
			$T_J = 175^{\circ}C$	35	39	45*	
			$T_J = -40^{\circ}C$	30	33	37	
Reverse Collector-Emitter Leakage Current	$I_{CES(R)}$	$V_{CE} = -24\text{ V}$ - NGD8205	$T_J = 25^{\circ}C$	0.05	0.25	0.5	mA
			$T_J = 175^{\circ}C$	1.0	12.5	25	
			$T_J = -40^{\circ}C$	0.005	0.03	0.25	
		$V_{CE} = -24\text{ V}$ - NGD8205A	$T_J = 25^{\circ}C$	0.05	0.25	1.0	
			$T_J = 175^{\circ}C$	1.0	12.5	25	
			$T_J = -40^{\circ}C$		0.03	0.25	
Gate-Emitter Clamp Voltage	$BV_{GES}$	$I_G = \pm 5.0\text{ mA}$	$T_J = -40^{\circ}C$ to $175^{\circ}C$	12	12.5	14	V
Gate-Emitter Leakage Current	$I_{GES}$	$V_{GE} = \pm 5.0\text{ V}$	$T_J = -40^{\circ}C$ to $175^{\circ}C$	200	300	350*	$\mu A$
Gate Resistor (Optional)	$R_G$		$T_J = -40^{\circ}C$ to $175^{\circ}C$		70		$\Omega$
Gate-Emitter Resistor	$R_{GE}$		$T_J = -40^{\circ}C$ to $175^{\circ}C$	14.25	16	25	k $\Omega$

### ON CHARACTERISTICS (Note 4)

Gate Threshold Voltage	$V_{GE(th)}$	$I_C = 1.0\text{ mA}$ , $V_{GE} = V_{CE}$	$T_J = 25^{\circ}C$	1.5	1.8	2.1	V
			$T_J = 175^{\circ}C$	0.7	1.0	1.3	
			$T_J = -40^{\circ}C$	1.7	2.0	2.3*	
Threshold Temperature Coefficient (Negative)				3.8	4.6	6.0	mV/ $^{\circ}C$

\*Maximum Value of Characteristic across Temperature Range.

3. Pulse Test: Pulse Width  $\leq 300\ \mu S$ , Duty Cycle  $\leq 2\%$ .

# NGD8205N, NGD8205AN

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
<b>ON CHARACTERISTICS</b> (Note 4)							
Collector-to-Emitter On-Voltage	$V_{CE(on)}$	$I_C = 6.5 \text{ A}, V_{GE} = 3.7 \text{ V}$	$T_J = 25^\circ\text{C}$	0.95	1.15	1.35	V
			$T_J = 175^\circ\text{C}$	0.7	0.95	1.15	
			$T_J = -40^\circ\text{C}$	1.0	1.3	1.40	
		$I_C = 9.0 \text{ A}, V_{GE} = 3.9 \text{ V}$	$T_J = 25^\circ\text{C}$	0.95	1.25	1.45	
			$T_J = 175^\circ\text{C}$	0.8	1.05	1.25	
			$T_J = -40^\circ\text{C}$	1.1	1.4	1.5	
		$I_C = 7.5 \text{ A}, V_{GE} = 4.5 \text{ V}$	$T_J = 25^\circ\text{C}$	0.85	1.15	1.4	
			$T_J = 175^\circ\text{C}$	0.7	0.95	1.2	
			$T_J = -40^\circ\text{C}$	1.0	1.3	1.6*	
		$I_C = 10 \text{ A}, V_{GE} = 4.5 \text{ V}$	$T_J = 25^\circ\text{C}$	1.0	1.3	1.6	
			$T_J = 175^\circ\text{C}$	0.8	1.05	1.4	
			$T_J = -40^\circ\text{C}$	1.1	1.4	1.7*	
		$I_C = 15 \text{ A}, V_{GE} = 4.5 \text{ V}$	$T_J = 25^\circ\text{C}$	1.15	1.45	1.7	
			$T_J = 175^\circ\text{C}$	1.0	1.3	1.55	
			$T_J = -40^\circ\text{C}$	1.25	1.55	1.8*	
		$I_C = 20 \text{ A}, V_{GE} = 4.5 \text{ V}$	$T_J = 25^\circ\text{C}$	1.3	1.6	1.9	
			$T_J = 175^\circ\text{C}$	1.2	1.5	1.8	
			$T_J = -40^\circ\text{C}$	1.4	1.75	2.0*	
Forward Transconductance	gfs	$I_C = 6.0 \text{ A}, V_{CE} = 5.0 \text{ V}$	$T_J = 25^\circ\text{C}$	10	18	25	Mhos

## DYNAMIC CHARACTERISTICS

Input Capacitance	$C_{ISS}$	$f = 10 \text{ kHz}, V_{CE} = 25 \text{ V}$	$T_J = 25^\circ\text{C}$	1100	1300	1500	pF
Output Capacitance	$C_{OSS}$			70	80	90	
Transfer Capacitance	$C_{RSS}$			18	20	22	

## SWITCHING CHARACTERISTICS

Turn-Off Delay Time (Resistive)	$t_{d(off)}$	$V_{CC} = 300 \text{ V}, I_C = 9.0 \text{ A}, R_G = 1.0 \text{ k}\Omega, R_L = 33 \Omega, V_{GE} = 5.0 \text{ V}$	$T_J = 25^\circ\text{C}$	6.0	8.0	10	$\mu\text{Sec}$
Fall Time (Resistive)	$t_f$		$T_J = 175^\circ\text{C}$	6.0	8.0	10	
			$T_J = 25^\circ\text{C}$	4.0	6.0	8.0	
Turn-Off Delay Time (Inductive)	$t_{d(off)}$		$T_J = 175^\circ\text{C}$	8.0	10.5	14	
		$T_J = 25^\circ\text{C}$	3.0	5.0	7.0		
Fall Time (Inductive)	$t_f$	$V_{CC} = 300 \text{ V}, I_C = 9.0 \text{ A}, R_G = 1.0 \text{ k}\Omega, L = 300 \mu\text{H}, V_{GE} = 5.0 \text{ V}$	$T_J = 175^\circ\text{C}$	5.0	7.0	9.0	
			$T_J = 25^\circ\text{C}$	1.5	3.0	4.5	
Turn-On Delay Time	$t_{d(on)}$		$T_J = 175^\circ\text{C}$	5.0	7.0	10	
			$T_J = 25^\circ\text{C}$	1.0	1.5	2.0	
Rise Time	$t_r$	$V_{CC} = 14 \text{ V}, I_C = 9.0 \text{ A}, R_G = 1.0 \text{ k}\Omega, R_L = 1.5 \Omega, V_{GE} = 5.0 \text{ V}$	$T_J = 175^\circ\text{C}$	1.0	1.5	2.0	
			$T_J = 25^\circ\text{C}$	4.0	6.0	8.0	
			$T_J = 25^\circ\text{C}$	4.0	6.0	8.0	
			$T_J = 175^\circ\text{C}$	3.0	5.0	7.0	

\*Maximum Value of Characteristic across Temperature Range.

4. Pulse Test: Pulse Width  $\leq 300 \mu\text{S}$ , Duty Cycle  $\leq 2\%$ .

# NGD8205N, NGD8205AN

## TYPICAL ELECTRICAL CHARACTERISTICS

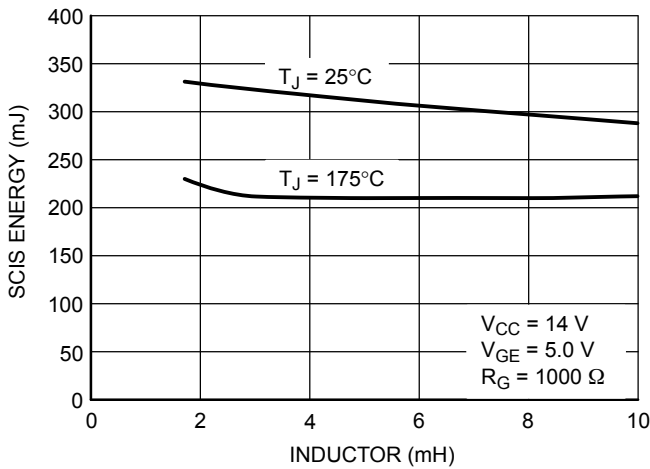


Figure 1. Self Clamped Inductive Switching

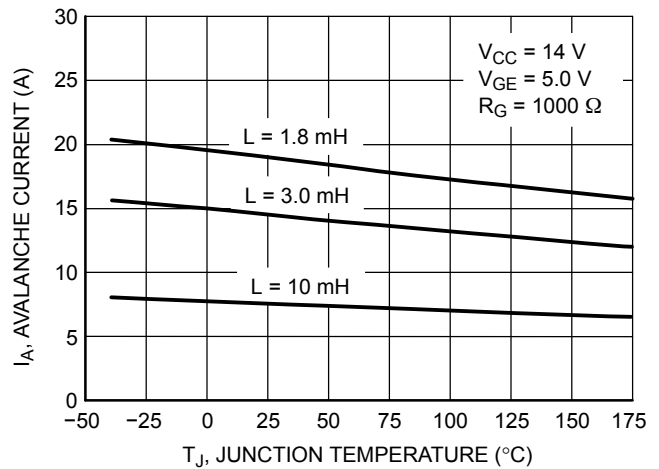


Figure 2. Open Secondary Avalanche Current vs. Temperature

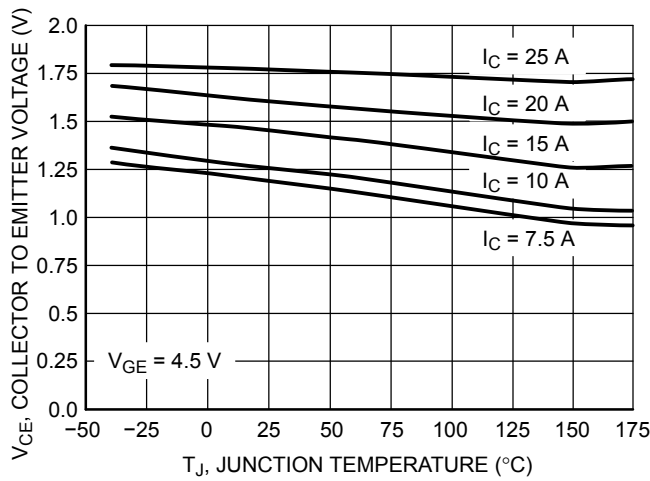


Figure 3. Collector-to-Emitter Voltage vs. Junction Temperature

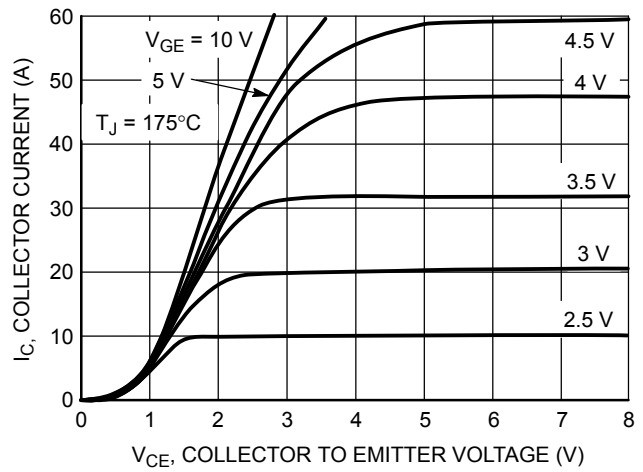


Figure 4. Collector Current vs. Collector-to-Emitter Voltage

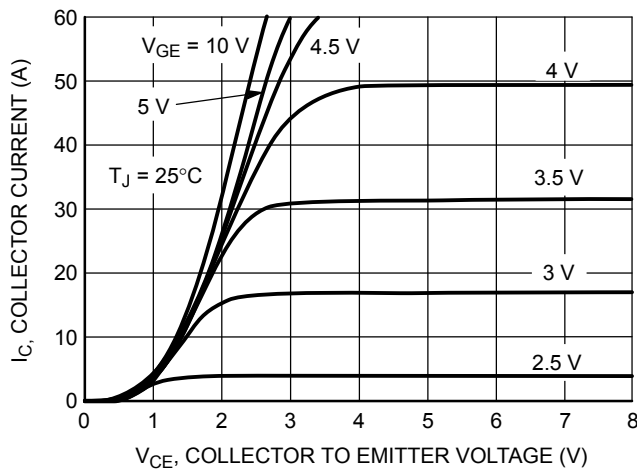


Figure 5. Collector Current vs. Collector-to-Emitter Voltage

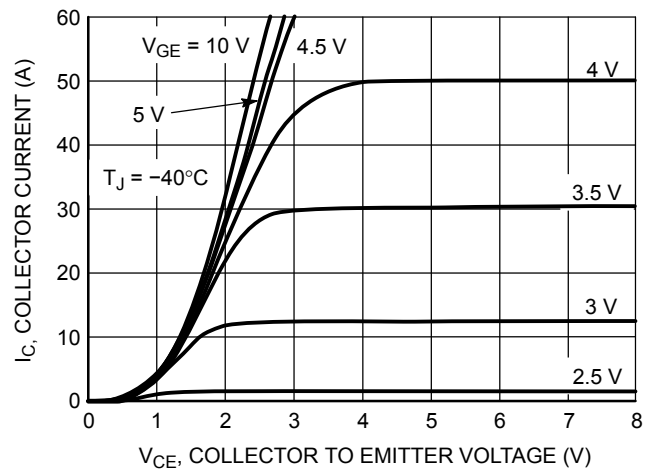


Figure 6. Collector Current vs. Collector-to-Emitter Voltage

# NGD8205N, NGD8205AN

## TYPICAL ELECTRICAL CHARACTERISTICS

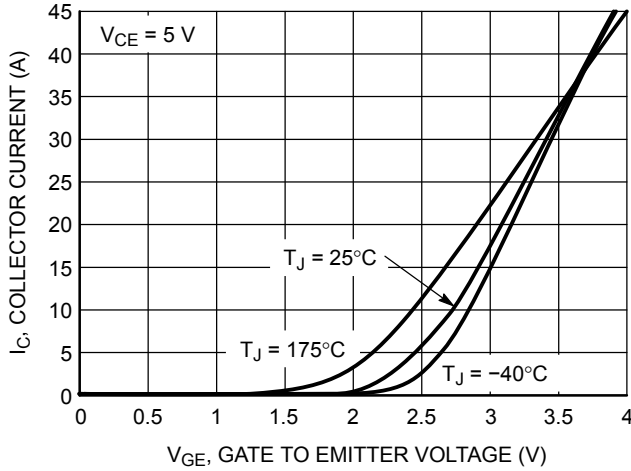


Figure 7. Transfer Characteristics

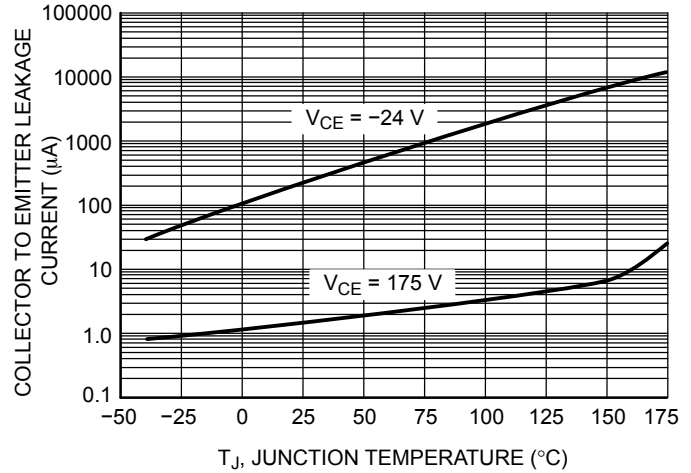


Figure 8. Collector-to-Emitter Leakage Current vs. Temperature

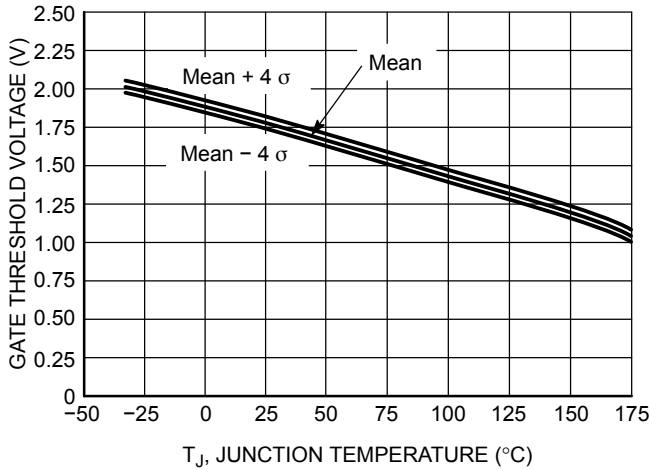


Figure 9. Gate Threshold Voltage vs. Temperature

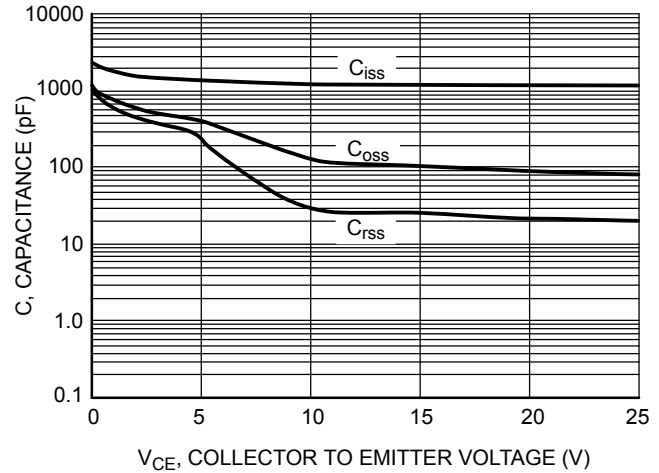


Figure 10. Capacitance vs. Collector-to-Emitter Voltage

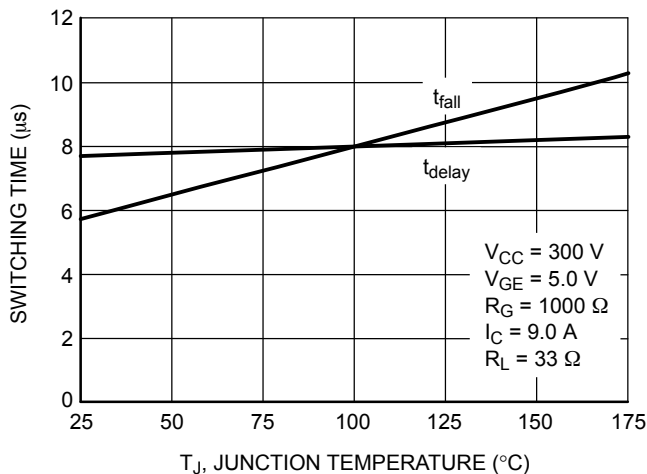


Figure 11. Resistive Switching Fall Time vs. Temperature

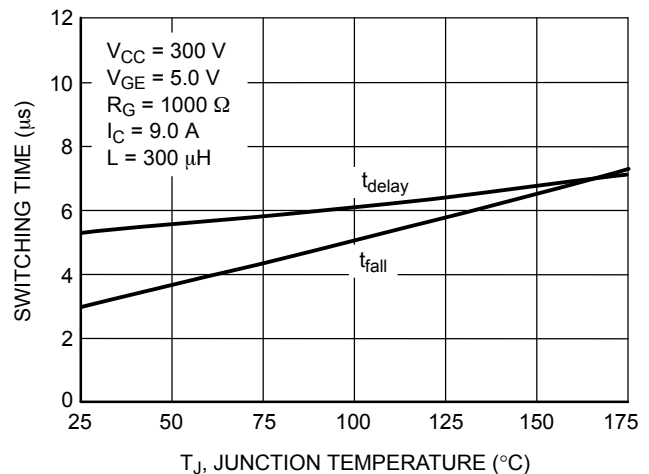
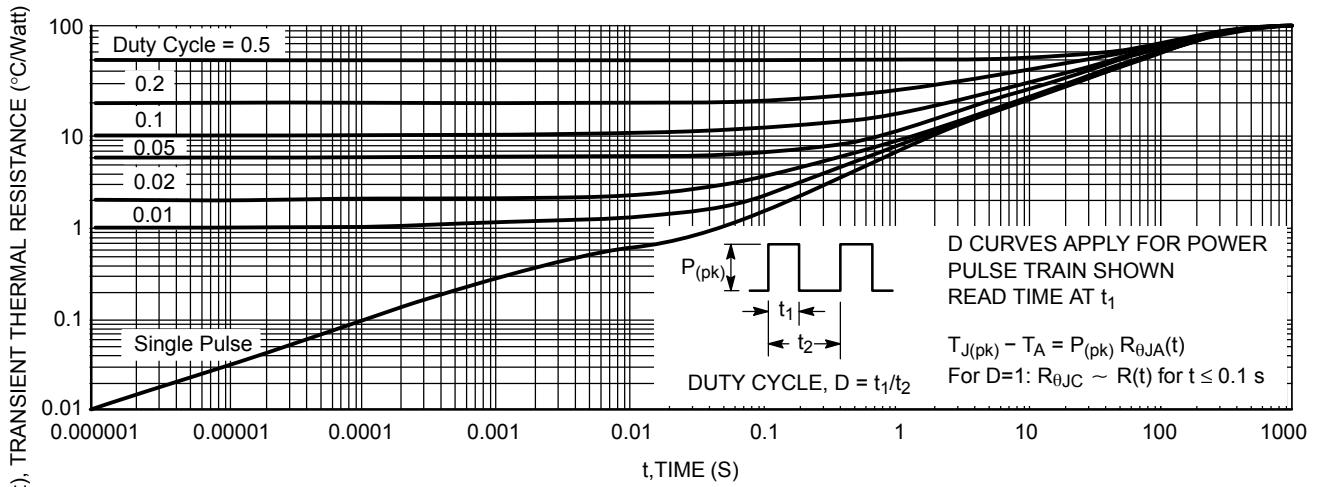
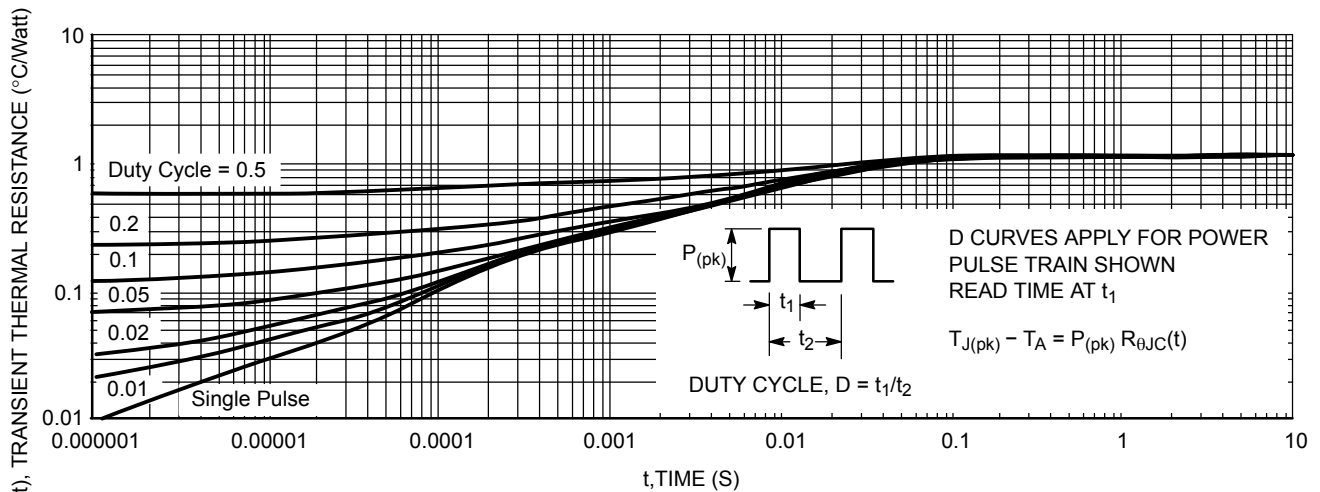


Figure 12. Inductive Switching Fall Time vs. Temperature

# NGD8205N, NGD8205AN



**Figure 13. Minimum Pad Transient Thermal Resistance  
(Non-normalized Junction-to-Ambient)**

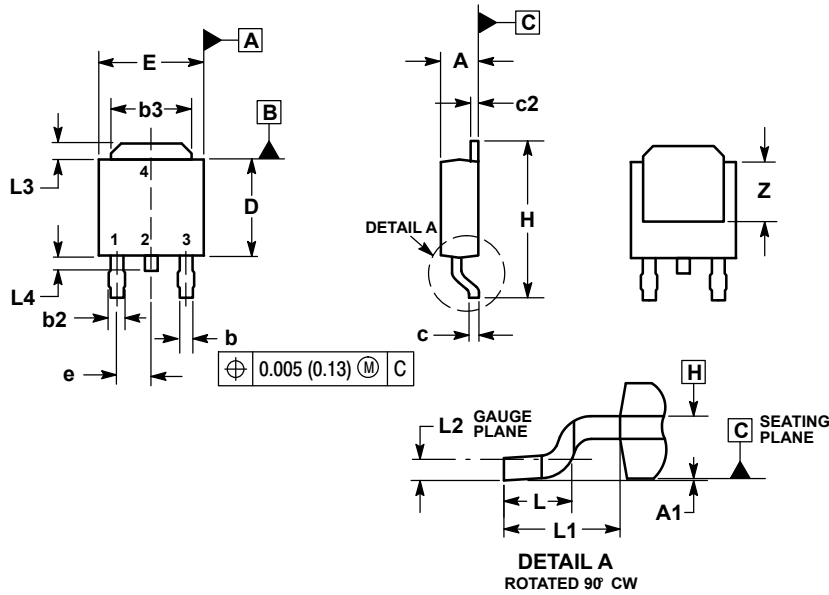


**Figure 14. Best Case Transient Thermal Resistance  
(Non-normalized Junction-to-Case Mounted on Cold Plate)**

# NGD8205N, NGD8205AN

## PACKAGE DIMENSIONS

### DPAK (SINGLE GAUGE) CASE 369C ISSUE D



**NOTES:**

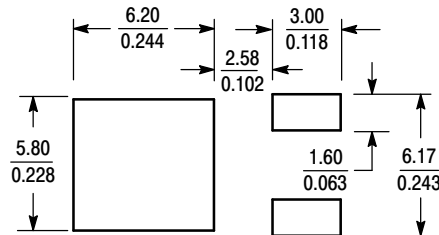
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.030	0.045	0.76	1.14
b3	0.180	0.215	4.57	5.46
c	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
e	0.090 BSC		2.29 BSC	
H	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.108 REF		2.74 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4	---	0.040	---	1.01
Z	0.155	---	3.93	---

**STYLE 7:**

- PIN 1. GATE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

### SOLDERING FOOTPRINT\*



SCALE 3:1 (mm / inches)

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